



Product Change Notification

Change Notification #: 116911 - 00
Change Title: Intel® Wi-Fi 6 AX200 SKUs:
AX200.D2WG.L; AX200.D2WG.LNV,
PCN 116911-00, Label, Label updates
Date of Publication: May 02, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 27, 2019
---	--------------

Description of Change to the Customer:

The Intel® Wireless-AX200 1216 SKUs listed in the products affected table below will undergo the following changes

1. Update labels to include China Regulatory Certification number, and update Argentina Regulatory logo
2. The Intel Tracking revision will be changed on the following products

Product code	Before	After
AX200.D2WG.L	0A	0B
AX200.D2WG.LNV	0A	0B

AX200.D2WG.L Reel Label (Before)

 AX200.D2WG.L	R/ID: XXXXXXXXXX	QTY: XXXX
MM #: XXXXXX		
TA: K52441-001	HP P/N: L41345-001	REV 0A
		
T P/N: GTTTTTTTTTT	XXXX-XXXXXXXXXXXX	
		
L P/N: SW10M73298	D P/N: PPPPPP	REV AXX
		





AX200.D2WG.L Reel Label (After)

 AX200.D2WG.L	R/ID: XXXXXXXXXX	QTY: XXXX
MM #: XXXXXX		
TA: K52441-002	HP P/N: L41345-001	REV 0B
		
T P/N: GTTTTTTTTTT	XXXX-XXXXXXXXXXXX	
		
L P/N: SW10M73298	D P/N: PPPPPP	REV AXX
		
























AX200.D2WG.L MBB Label (Before)

AX200.D2WG.L		QTY: 1000		MM#: XXXXXX		Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)		PKG ID (3S) VVVVMMMMDDDD#####PPPPP100	T P/N: GTTTTTTTTTT							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com	
VERSION #: K52441-001		MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0A							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0A	L P/N: SW10M73298	EC: 2557226							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com

AX200.D2WG.L MBB Label (After)



AX200.D2WG.L		QTY: 1000		MM#: XXXXXX		Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)		PKG ID (3S) VVVVMMMMDDDD#####PPPPP100	T P/N: GTTTTTTTTTT							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com	
VERSION #: K52441-002		MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0B							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0B	L P/N: SW10M73298	EC: 2557226							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com



AX200.D2WG.L Disti Label (Before)

AX200.D2WG.L		QTY: 1000		MM#: XXXXXX		Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)		PKG ID (3S) VVVVMMMMDDDD#####PPPPP100	T P/N: GTTTTTTTTTT							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com	
VERSION #: K52441-001		MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0A							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0A	L P/N: SW10M73298	EC: 2557226							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com







AX200.D2WG.L Disti Label (After)







AX200.D2WG.L		QTY: 1000		MM#: XXXXXX		Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)		PKG ID (3S) VVVVMMMMDDDD#####PPPPP100	T P/N: GTTTTTTTTTT							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com	
VERSION #: K52441-002		MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0B							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	CARTON #: VVXXXXXXX	PACK DATE: DD MMM YY	PACKED BY: XXXXXX	BATCH #: CCVVYMDRSS	D P/N: PPPPPP	REV AXX	HP P/N: L41345-001	REV: 0B	L P/N: SW10M73298	EC: 2557226							Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1548 USA www.intel.com

<p>AX200.D2WG.LNV Reel Label (Before)</p>  <p>AX200.D2WG.LNV R/ID: XXXXXXXXXX QTY: XXXX MM #: XXXXXX TA: K34405-001 HP P/N: L41343-001 REV 0A T P/N: GTTTTTTTTTT XXXX-XXXXXXXXXXXX L P/N: SW10M73299 D P/N: PPPPPP REV AXX</p>	<p>AX200.D2WG.LNV Reel Label (After)</p>  <p>AX200.D2WG.LNV R/ID: XXXXXXXXXX QTY: XXXX MM #: XXXXXX TA: K34405-002 HP P/N: L41343-001 REV 0B T P/N: GTTTTTTTTTT XXXX-XXXXXXXXXXXX L P/N: SW10M73299 D P/N: PPPPPP REV AXX</p>
--	---

<p>AX200.D2WG.LNV MBB Label (Before)</p> <p>AX200.D2WG.LNV QTY: 1000 MM#: XXXXXX VERSION #: K34405-001 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)</p> <p>PKG ID (3S) VVVVMMMMDDDD#####PPPPP100 T P/N: GTTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXX HP P/N: L41343-001 REV: 0A Mfg Id: VVVVVLLLLL Mfg Id: MMMMMM L P/N: SW10M73299 EC: 2557226</p>	      <p>Intel Corporation 2200 Riverine College Blvd Santa Clara, CA 95054-1648 USA www.intel.com</p> <p>003-190022 0.10-2.0 g/mq. Max. use only. Recycled content: 100% (high power mode) 100% recycled</p> <p>R-C-INTEL-AX200D2WL</p>
---	---	---

<p>AX200.D2WG.LNV MBB Label (After)</p> <p>AX200.D2WG.LNV QTY: 1000 MM#: XXXXXX VERSION #: K34405-002 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)</p> <p>PKG ID (3S) VVVVMMMMDDDD#####PPPPP100 T P/N: GTTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXX HP P/N: L41343-001 REV: 0B Mfg Id: VVVVVLLLLL Mfg Id: MMMMMM L P/N: SW10M73299 EC: 2557226</p>	      <p>Intel Corporation 2200 Riverine College Blvd Santa Clara, CA 95054-1648 USA www.intel.com</p> <p>003-190022 0.10-2.0 g/mq. Max. use only. Recycled content: 100% (high power mode) 100% recycled</p> <p>R-C-INTEL-AX200D2WL</p>
--	---	---

<p>AX200.D2WG.LNV Disti Label (Before)</p> <p>AX200.D2WG.LNV QTY: 1000 MM#: XXXXXX VERSION #: K34405-001 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)</p> <p>PKG ID (3S) VVVVMMMMDDDD#####PPPPP100 T P/N: GTTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXX HP P/N: L41343-001 REV: 0A Mfg Id: VVVVVLLLLL Mfg Id: MMMMMM L P/N: SW10M73299 EC: 2557226</p>	      <p>Intel Corporation 2200 Riverine College Blvd Santa Clara, CA 95054-1648 USA www.intel.com</p> <p>003-190022 0.10-2.0 g/mq. Max. use only. Recycled content: 100% (high power mode) 100% recycled</p> <p>R-C-INTEL-AX200D2WL</p>
---	---	---

<p>AX200.D2WG.LNV Disti Label (After)</p> <p>AX200.D2WG.LNV QTY: 1000 MM#: XXXXXX VERSION #: K34405-002 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Wi-Fi 6 AX200 (Model: AX200D2WL)</p> <p>PKG ID (3S) VVVVMMMMDDDD#####PPPPP100 T P/N: GTTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXX HP P/N: L41343-001 REV: 0B Mfg Id: VVVVVLLLLL Mfg Id: MMMMMM L P/N: SW10M73299 EC: 2557226</p>	      <p>Intel Corporation 2200 Riverine College Blvd Santa Clara, CA 95054-1648 USA www.intel.com</p> <p>003-190022 0.10-2.0 g/mq. Max. use only. Recycled content: 100% (high power mode) 100% recycled</p> <p>R-C-INTEL-AX200D2WL</p>
--	---	---

Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
AX200.D2WG.L	985942	K52441-001	K52441-002
AX200.D2WG.LNV	985952	K34405-001	K34405-002

PCN Revision History:

Date of Revision:

May 2, 2019

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

116911 - 00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2019. Other names and brands may be claimed as the property of others.

3D XPoint, Axxia, Basis, Basis Peak, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, Curie, Flexpipe, Intel, the Intel logo, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Inside, the Intel Inside logo, Intel Insider, Intel Joule, Intel RealSense, Intel SingleDriver, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Iris, Itanium, MCS, MMX, Optane, Ostro, Pali, Pentium, picoArray, Picochip, picoXcell, Puma, Quark, SMARTi, Soletta, Sound Mark, StarPro, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcende, True Key, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS® Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos. Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.